



DOCUMENT CHANGE REQUEST

DCR number		1708		Changes required for: General		Originator: Stephan Hernandez	
Date: 2025/01/09				Date sent: 2025/01/07		Organisation: ESTEC	
Status: IMPLEMENTED							
Title:		REP007 European Preferred Parts List					
Number:		REP007		Issue:		49	
Other documents affected:							
Page:							
-							
Paragraph:							
-							
Original wording:							
-							
Proposed wording:							
New entries:							
Microchip Technology, EPPL part 1							
ARM Cortex-M7 Microcontroller (SAMV71RT)							
UMS / France, Germany, EPPL part 2							
Plastic QFN packaging has been added for GH25-10 and GH15-10 GaN technologies. See Note 19 pag. 59 for details.							
Frontgrade Technologies / USA, EPPL part 2							
4Tb NAND Flash based on type UT81NDQ512G8T							
Editorial:							
Advanced Space Power Equipment (ASP) / Germany, EPPL part 2							
Manufacturer name has been clarified: Advanced Space Power Equipment instead of ASP							
Justification:							
Publication EPPL December 2024							

Attachments:

N/A

Modifications:

N/A

Approval signature:



Date signed:

2025-01-09